

# MX27C4000

## 4M-BIT [512K x8] CMOS EPROM

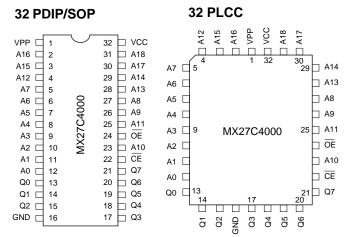
### FEATURES

- 512K x 8 organization
- Single +5V power supply
- +12.5V programming voltage
- Fast access time: 90/100/120/150 ns
- Totally static operation
- Completely TTL compatible

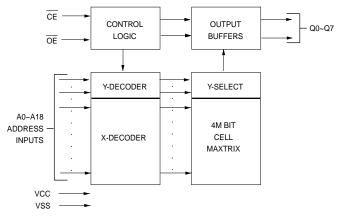
### **GENERAL DESCRIPTION**

The MX27C4000 is a 5V only, 4M-bit, One Time Programmable Read Only Memory. It is organized as 512K words by 8 bits per word, operates from a single +5 volt supply, has a static standby mode, and features fast single address location programming. All programming signals are TTL levels, requiring a single pulse. For programming outside from the system, existing EPROM

### **PIN CONFIGURATIONS**



### **BLOCK DIAGRAM**



- Operating current: 40mA
- Standby current: 100uA
- Package type:
  - 32 pin plastic DIP
  - 32 pin PLCC/SOP
  - 32 pin TSOP

**32 TSOP** 

programmers may be used. The MX27C4000 supports a intelligent fast programming algorithm which can result in programming time of less than two minutes.

This EPROM is packaged in industry standard 32 pin dual-in-line packages, 32 lead PLCC, 32 lead SOP, and 32 lead TSOP packages.

#### ŌE 32 A11 A9 2 31 A10 A8 3 30 CE A13 4 29 Q7 Q6 A14 28 5 27 Q5 A17 6 Г A18 7 26 Q4 VCC 8 25 03 MX27C4000 VPP 24 GND 9 A16 10 23 Q2 22 Q1 A15 11 A12 12 21 Q0 13 20 A0 A7 14 19 □ A1 A6 15 A5 Г 18 A2 A4 16 17 A3

### **PIN DESCRIPTION**

SYMBOL	PIN NAME
A0~A18	Address Input
Q0~Q7	Data Input/Output
CE	Chip Enable Input
ŌĒ	Output Enable Input
VPP	Program Supply Voltage
VCC	Power Supply Pin (+5V)
GND	Ground Pin



### FUNCTIONAL DESCRIPTION

#### THE PROGRAMMING OF THE MX27C4000

When the MX27C4000 is delivered, or it is erased, the chip has all 4M bits in the "ONE" or HIGH state. "ZEROs" are loaded into the MX27C4000 through the procedure of programming.

For programming, the data to be programmed is applied with 8 bits in parallel to the data pins.

Vcc must be applied simultaneously or before Vpp, and removed simultaneously or after Vpp. When programming an MXIC EPROM, a 01uF capacitor is required across Vpp and ground to suppress spurious voltage transients which may damage the device.

#### **FAST PROGRAMMING**

The device is set up in the fast programming mode when the programming voltage VPP = 12.75V is applied, with VCC = 6.25 V and  $\overline{OE}$  = VIH (Algorithm is shown in Figure 1). The programming is achieved by applying a single TTL low level 100us pulse to the  $\overline{CE}$  input after addresses and data line are stable. If the data is not verified, an additional pulse is applied for a maximum of 25 pulses. This process is repeated while sequencing through each address of the device. When the programming mode is completed, the data in all address is verified at VCC = VPP = 5V ± 10%.

### **PROGRAM INHIBIT MODE**

Programming of multiple MX27C4000s in parallel with different data is also easily accomplished by using the Program Inhibit Mode. Except for  $\overline{CE}$  and  $\overline{OE}$ , all like inputs of the parallel MX27C4000 may be common. A TTL low-level program pulse applied to an MX27C4000  $\overline{CE}$  input with VPP = 12.5 ± 0.5 V and  $\overline{CE}$  LOW will program that MX27C4000. A high-level  $\overline{CE}$  input inhibits the other MX27C4000s from being programmed.

### PROGRAM VERIFY MODE

Verification should be performed on the programmed bits to determine that they were correctly programmed. The verification should be performed with  $\overline{OE}$  and  $\overline{CE}$  at VIL, and VPP at its programming voltage.

#### AUTO IDENTIFY MODE

The auto identify mode allows the reading out of a binary code from an EPROM that will identify its manufacturer and device type. This mode is intended for use by programming equipment for the purpose of automatically matching the device to be programmed with its corresponding programming algorithm. This mode is functional in the  $25 \,^{\circ}\text{C} \pm 5 \,^{\circ}\text{C}$  ambient temperature range that is required when programming the MX27C4000.

To activate this mode, the programming equipment must force  $12.0 \pm 0.5$  V on address line A9 of the device. Two identifier bytes may then be sequenced from the device outputs by toggling address line A0 from VIL to VIH. All other address lines must be held at VIL during auto identify mode.

Byte 0 (A0 = VIL) represents the manufacturer code, and byte 1 (A0 = VIH), the device identifier code. For the MX27C4000, these two identifier bytes are given in the Mode Select Table. All identifiers for manufacturer and device codes will possess odd parity, with the MSB (Q7) defined as the parity bit.

### **READ MODE**

The MX27C4000 has two control functions, both of which must be logically satisfied in order to obtain data at the outputs. Chip Enable  $\overline{(CE)}$  is the power control and should be used for device selection. Output Enable  $\overline{(OE)}$  is the output control and should be used to gate data to the output pins, independent of device selection. Assuming that addresses are stable, address access time (tACC) is equal to the delay from  $\overline{CE}$  to output (tCE). Data is available at the outputs tOE after the falling edge of  $\overline{OE}$ 's, assuming that  $\overline{CE}$  has been LOW and addresses have been stable for at least tACC - tOE.

#### STANDBY MODE

The MX27C4000 has a CMOS standby mode which reduces the maximum VCC current to 100 uA. It is placed in CMOS standby when  $\overline{CE}$  is at VCC  $\pm$  0.3 V. The MX27C4000 also has a TTL-standby mode which reduces the maximum VCC current to 1.5 mA. It is placed in TTL-standby when  $\overline{CE}$  is at VIH. When in standby mode, the outputs are in a high-impedance state, independent of the  $\overline{OE}$  input.



#### TWO-LINE OUTPUT CONTROL FUNCTION

To accommodate multiple memory connections, a twoline control function is provided to allow for:

1. Low memory power dissipation,

2. Assurance that output bus contention will not occur.

It is recommended that  $\overline{CE}$  be decoded and used as the primary device-selecting function, while  $\overline{OE}$  be made a common connection to all devices in the array and connected to the READ line from the system control bus. This assures that all deselected memory devices are in their low-power standby mode and that the output pins are only active when data is desired from a particular memory device.

#### SYSTEM CONSIDERATIONS

During the switch between active and standby conditions, transient current peaks are produced on the rising and falling edges of Chip Enable. The magnitude of these transient current peaks is dependent on the output capacitance loading of the device. At a minimum, a 0.1 uF ceramic capacitor (high frequency, low inherent inductance) should be used on each device between VCC and GND to minimize transient effects. In addition, to overcome the voltage drop caused by the inductive effects of the printed circuit board traces on EPROM arrays, a 4.7 uF bulk electrolytic capacitor should be used between VCC and GND for each eight devices. The location of the capacitor should be close to where the power supply is connected to the array.

### **MODE SELECT TABLE**

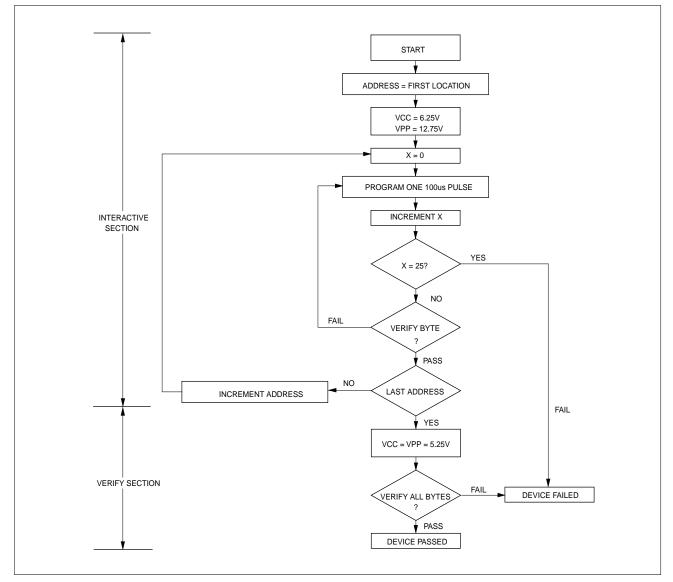
				PINS		
IODE	CE	OE	A0	A9	VPP	OUTPUTS
ead	VIL	VIL	Х	Х	VCC	DOUT
output Disable	VIL	VIH	Х	Х	VCC	High Z
tandby (TTL)	VIH	Х	Х	Х	VCC	High Z
tandby (CMOS)	VCC±0.3V	Х	Х	Х	VCC	High Z
rogram	VIL	VIH	Х	Х	VPP	DIN
rogram Verify	VIH	VIL	Х	Х	VPP	DOUT
rogram Inhibit	VIH	VIH	Х	Х	VPP	High Z
lanufacturer Code(3)	VIL	VIL	VIL	VH	VCC	C2H
evice Code(3)	VIL	VIL	VIH	VH	VCC	40H

**NOTES:** 1. VH =  $12.0 \text{ V} \pm 0.5 \text{ V}$ 2. X = Either VIH or VIL 3. A1 - A8 = A10 - A18 = VIL(For auto select)

4. See DC Programming Characteristics for VPP voltage during programming.

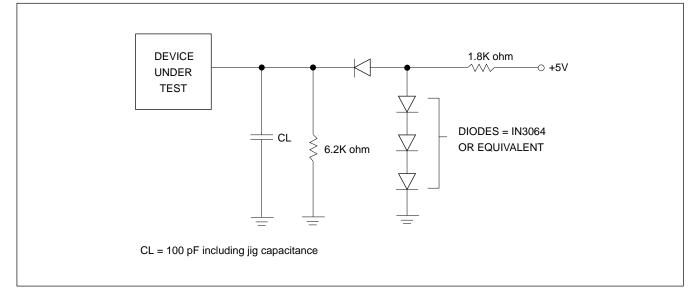


FIGURE 1. FAST PROGRAMMING FLOW CHART

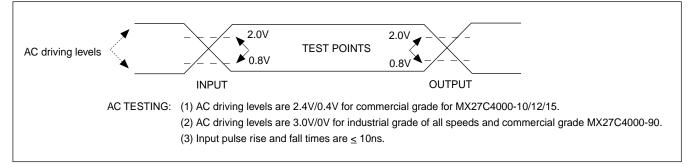




### SWITCHING TEST CIRCUITS



### SWITCHING TEST WAVEFORMS





### **ABSOLUTE MAXIMUM RATINGS**

RATING	VALUE
Ambient Operating Temperature	-40℃ to 85℃
Storage Temperature	-65 ℃ to 125 ℃
Applied Input Voltage	-0.5V to 7.0V
Applied Output Voltage	-0.5V to VCC + 0.5V
VCC to Ground Potential	-0.5V to 7.0V
V9 & VPP	-0.5V to 13.5V

#### NOTICE:

Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended period may affect reliability.

#### NOTICE:

Specifications contained within the following tables are subject to change.

### DC/AC Operating Conditions for Read Operation

MX27C4000							
		-90	-10	-12	-15		
Operating	Commercial	0℃ to 70℃	0℃ to 70℃	0℃ to 70℃	0℃ to 70℃		
Temperature	Industrial			-40℃ to 85℃	-40℃ to 85℃		
Vcc Power Sup	ply	5V ± 10%	5V ± 10%	5V ± 10%	5V ± 10%		

### **DC CHARACTERISTICS**

SYMBOL	PARAMETER	MIN.	MAX.	UNIT	CONDITIONS
VOH	Output High Voltage	2.4		V	IOH = -0.4mA
VOL	Output Low Voltage		0.4	V	IOL = 2.1 mA
VIH	Input High Voltage	2.0	VCC + 0.5	V	
VIL	Input Low Voltage	-0.3	0.8	V	
ILI	Input Leakage Current	-10	10	uA	VIN = 0 to 5.5V
ILO	Output Leakage Current	-10	10	uA	VOUT = 0 to 5.5V
ICC3	VCC Power-Down Current		100	uA	$\overline{\text{CE}} = \text{VCC} \pm 0.3\text{V}$
ICC2	VCC Standby Current		1.5	mA	CE = VIH
ICC1	VCC Active Current		40	mA	$\overline{CE}$ = VIL, f=5MHz, lout = 0mA
IPP	VPP Supply Current Read		10	uA	$\overline{CE} = \overline{OE} = VIL, VPP = 5.5V$

### CAPACITANCE

SYMBOL	PARAMETER	TYP.	MAX.	UNIT	CONDITIONS
CIN	Input Capacitance	8	12	pF	VIN = 0V
COUT	Output Capacitance	8	12	pF	VOUT = 0V
CVPP	VPP Capacitance	18	25	pF	VPP = 0V



### **AC CHARACTERISTICS**

		27C400	00-90	<u>27C40</u>	<u>00-10</u>	27C40	<u>00-12</u>	27C40	<u>000-15</u>		
SYMBOL	PARAMETER	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	UNIT	CONDITIONS
tACC	Address to Output Delay		90		100		120		150	ns	$\overline{CE} = \overline{OE} = VIL$
tCE	Chip Enable to Output Delay		90		100		120		150	ns	$\overline{OE} = VIL$
tOE	Output Enable to Output Delay		40		45		50		65	ns	CE = VIL
tDF	OE High to Output Float,	0	25	0	30	0	35	0	50	ns	
	or $\overline{\text{CE}}$ High to Output Float										
tOH	Output Hold from Address,	0		0		0		0		ns	
	$\overline{CE}$ or $\overline{OE}$ which ever occurred fir	st									

### **DC PROGRAMMING CHARACTERISTICS** $TA = 25 \circ C \pm 5 \circ C$

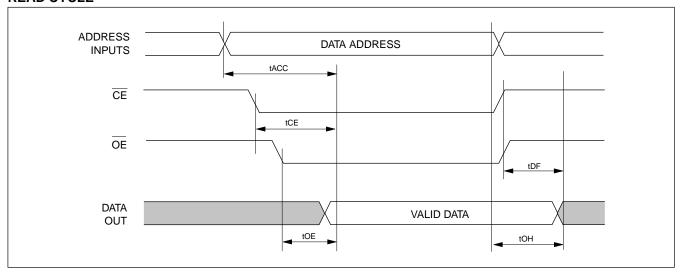
SYMBOL	PARAMETER	MIN.	MAX.	UNIT	CONDITIONS
VOH	Output High Voltage	2.4		V	IOH = -0.40mA
VOL	Output Low Voltage		0.4	V	IOL = 2.1 mA
VIH	Input High Voltage	2.0	VCC + 0.5	V	
VIL	Input Low Voltage	-0.3	0.8	V	
ILI	Input Leakage Current	-10	10	uA	VIN = 0 to 5.5V
VH	A9 Auto Select Voltage	11.5	12.5	V	
ICC3	VCC Supply Current (Program & Verify)		50	mA	
IPP2	VPP Supply Current(Program)		30	mA	$\overline{CE} = VIL, \overline{OE} = VIH$
VCC1	Fast Programming Supply Voltage	6.00	6.50	V	
VPP1	Fast Programming Voltage	12.5	13.0	V	

### **AC PROGRAMMING CHARACTERISTICS** $TA = 25 \circ C \pm 5 \circ C$

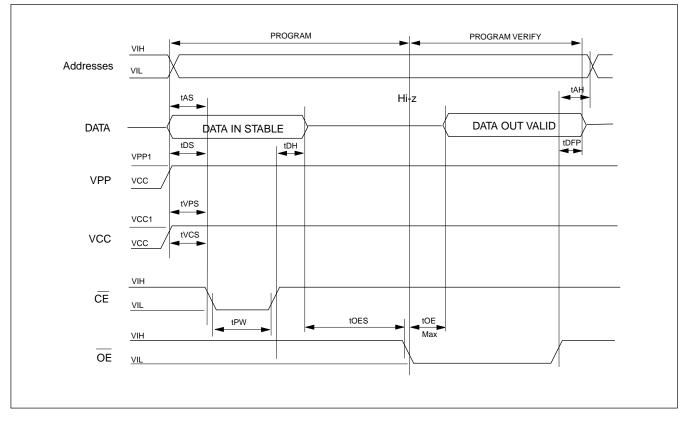
SYMBOL	PARAMETER	MIN.	MAX.	UNIT	CONDITIONS
tAS	Address Setup Time	2.0		us	
tOES	OE Setup Time	2.0		us	
tDS	Data Setup Time	2.0		us	
tAH	Address Hold Time	0		us	
tDH	Data Hold Time	2.0		us	
tDFP	Out put Enable to Output Float Delay	0	130	ns	
tVPS	VPP Setup Time	2.0		us	
tPW	PGM Program Pulse Width	95	105	us	
tVCS	VCC Setup Time	2.0		us	
tOE	Data valid from OE		150	ns	
,					



#### WAVEFORMS READ CYCLE



### FAST PROGRAMMING ALGORITHM WAVEFORM





### ORDERING INFORMATION

#### PLASTIC PACKAGE

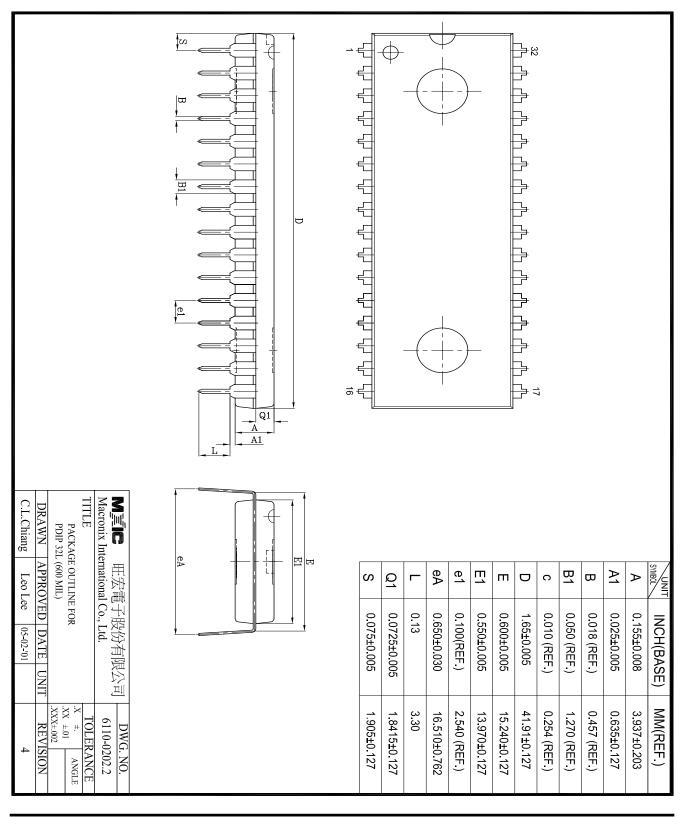
PART NO.	ACCESS TIME(ns)	OPERATING	STANDBY	OPERATING	PACKAGE
		CURRENT MAX.(mA)	CURRENT MAX.(uA)	TEMPERATURE	
MX27C4000PC-90	90	40	100	0℃ to 70℃	32 Pin DIP
MX27C4000QC-90	90	40	100	0℃ to 70℃	32 Pin PLCC
MX27C4000MC-90	90	40	100	0℃ to 70℃	32 Pin SOP
MX27C4000PC-10	100	40	100	0℃ to 70℃	32 Pin DIP
MX27C4000QC-10	100	40	100	0℃ to 70℃	32 Pin PLCC
MX27C4000MC-10	100	40	100	0℃ to 70℃	32 Pin SOP
MX27C4000PC-12	120	40	100	0℃ to 70℃	32 Pin DIP
MX27C4000QC-12	120	40	100	0℃ to 70℃	32 Pin PLCC
MX27C4000MC-12	120	40	100	0℃ to 70℃	32 Pin SOP
MX27C4000TC-12	120	40	100	0℃ to 70℃	32 PIn TSOP
MX27C4000PC-15	150	40	100	0℃ to 70℃	32 Pin DIP
MX27C4000QC-15	150	40	100	0℃ to 70℃	32 Pin PLCC
MX27C4000MC-15	150	40	100	0℃ to 70℃	32 Pin SOP
MX27C4000TC-15	150	40	100	0℃ to 70℃	32 Pin TSOP
MX27C4000PI-12	120	40	100	-40 ℃ to 85 ℃	32 Pin DIP
MX27C4000QI-12	120	40	100	-40 ℃ to 85 ℃	32 Pin PLCC
MX27C4000MI-12	120	40	100	-40℃ to 85℃	32 Pin SOP
MX27C4000TI-12	120	40	100	-40℃ to 85℃	32 PIn TSOP
MX27C4000PI-15	150	40	100	-40 ℃ to 85 ℃	32 Pin DIP
MX27C4000QI-15	150	40	100	-40 ℃ to 85 ℃	32 Pin PLCC
MX27C4000MI-15	150	40	100	-40℃ to 85℃	32 Pin SOP
MX27C4000TI-15	150	40	100	-40℃ to 85℃	32 Pin TSOP



MX27C4000

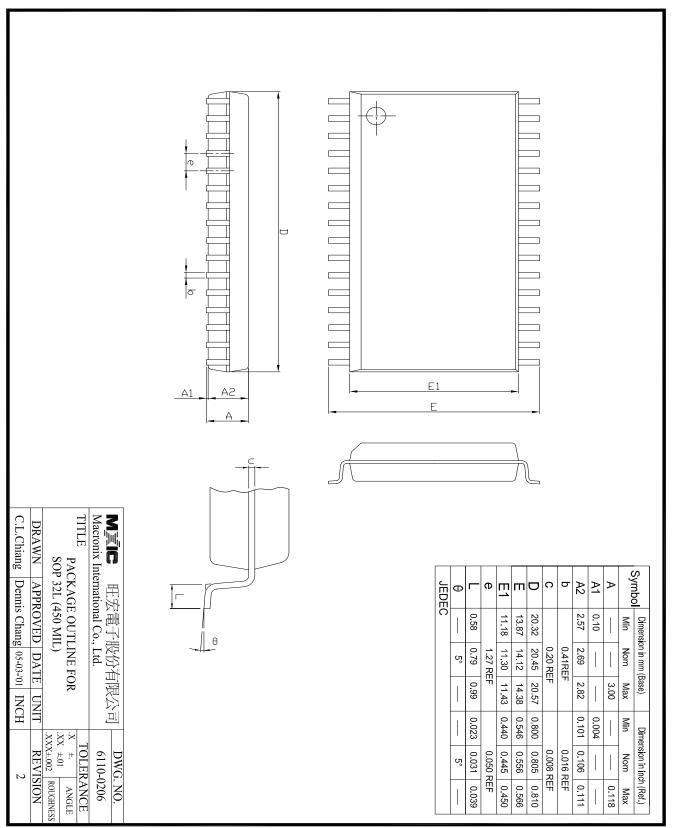
### **PACKAGE INFORMATION**

#### 32-PIN PLASTIC DIP(600 mil)



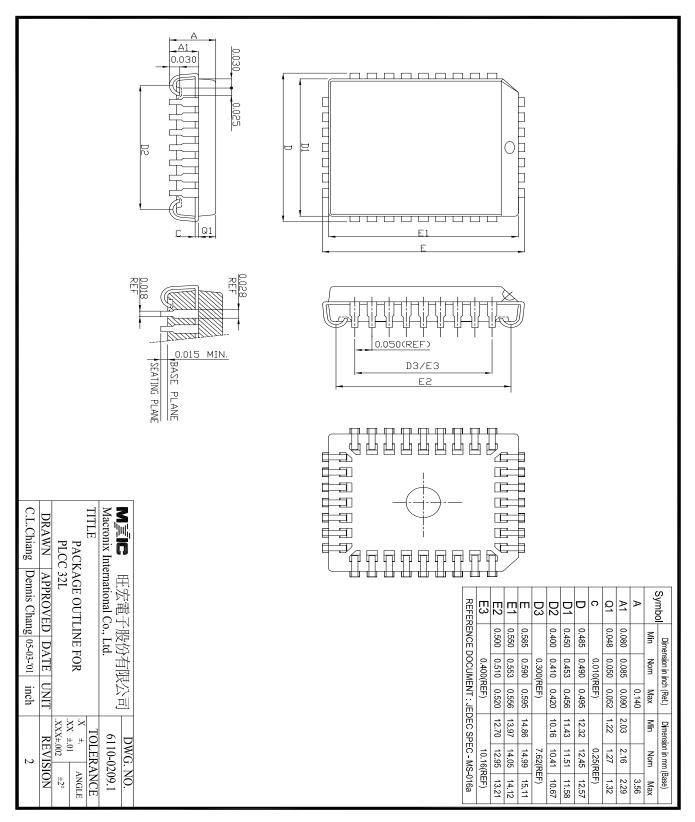


#### 32-PIN PLASTIC SOP (450 mil)





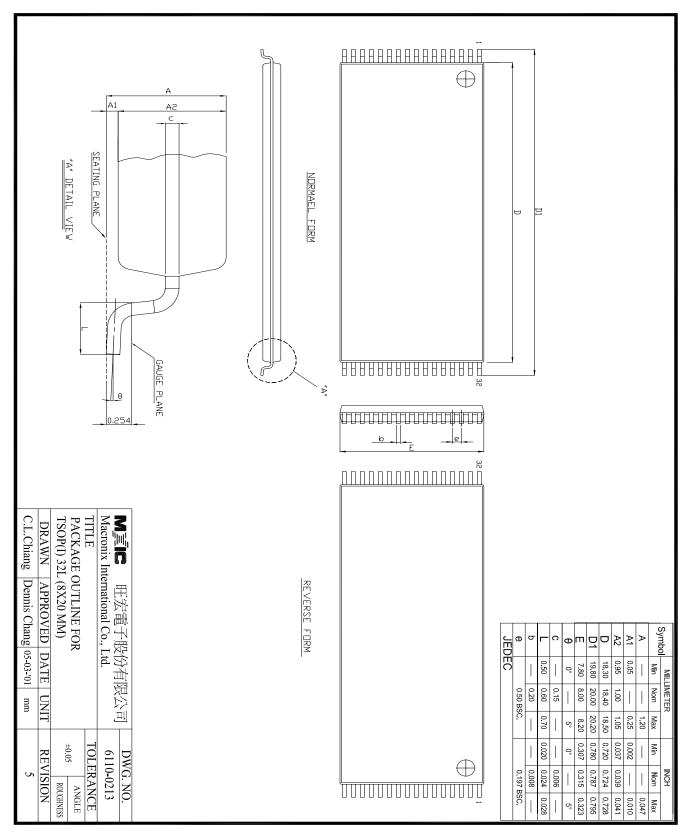
### 32-PIN PLASTIC LEADED CHIP CARRIER (PLCC)







#### **32-PIN PLASTIC TSOP**





### **REVISION HISTORY**

Revisio	n No. Description	Page	Date
3.0	1) Eliminate Interactive Programming Mode.	-	5/29/1997
	2) MX27C4000-90 AC driving levels changed from 2.4V/0.4V to 3	3.0V/0V.	
3.1	IPP1 100uA> 10uA		7/17/1997
3.2	Change TSOP Orientation.		4/09/1998
3.3	Cancel ceramic DIP package type	P1,2,9,10	MAR/01/2000
3.4	Cancel "Ultraviolet Erasable" wording in General Description	P1	AUG/20/2001
	To modify Package Information	P10~13	



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